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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# **Slotted Optical Switch**

## **OPB855**



#### **Features:**

- Low profile 0.27" (6.86 mm) overall height
- Printed PCBoard mounting
- 0.205" (5.21 mm) wide and 0.220 (5.59 mm) deep slot
- 0.380" (9.65 mm) lead spacing
- Opaque plastic housing

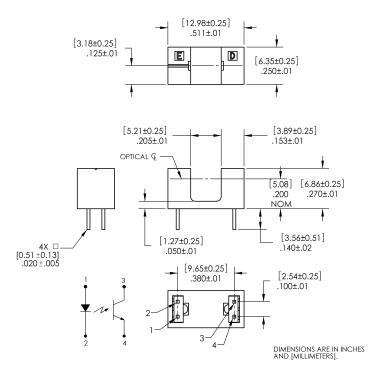


### **Description:**

The OPB855 slotted optical switch consists of an infrared emitting diode and a NPN silicon phototransistor, mounted on opposite sides of a 0.205" (5.21 mm) wide slot in an inexpensive plastic housing. Switching of the phototransistor occurs whenever an opaque object passes through the slot.

## **Applications:**

- Non-contact interruptive object sensing
- Assembly line automation
- Machine automation
- · Equipment security
- Machine safety



Pin#	Description
1	Anode
2	Cathode
3	Collector
4	Emitter



# **Slotted Optical Switch**

## **OPB855**



## **Electrical Specifications**

## Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Storage & Operating Temperature Range	-40°C to +85° C
Lead Soldering Temperature [1/16 inch (1.6mm) from the case for 5 sec. with soldering iron] <sup>(1)</sup>	260° C

## Input Diode (See OP140 for additional information)

Forward DC Current	50 mA
Peak Forward Current (1 μs pulse width, 300 pps)	1 A
Reverse DC Voltage	2 V
Power Dissipation <sup>(2)</sup>	100 mW

## Output Phototransistor (See OP550 for additional information)

Collector-Emitter Voltage	30 V
Emitter-Collector Voltage	5 V
Collector DC Current	30 mA
Power Dissipation <sup>(2)</sup>	100 mW

## Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS		
Input Diode								
V <sub>F</sub>	Forward Voltage	-	1.30	1.80	V	I <sub>F</sub> = 20 mA		
I <sub>R</sub>	Reverse Current	-	-	100	μА	V <sub>R</sub> = 2 V		
Output Pho	totransistor							
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	30	-	-	V	I <sub>C</sub> = 1 mA		
V <sub>(BR)ECO</sub>	Emitter-Collector Breakdown Voltage	5	-	-	V	I <sub>E</sub> = 100 μA		
I <sub>CEO</sub>	Collector-Emitter Dark Current	-	-	100	nA	$V_{CE} = 10 \text{ V}, I_F = 0, E_E = 0$		
Combined								
V <sub>CE(SAT)</sub>	Collector-Emitter Saturation Voltage	-	-	0.4	V	I <sub>C</sub> = 400 μA, I <sub>F</sub> = 20 mA		
I <sub>C(ON)</sub>	On-State Collector Current	1.50	-	20.0	mA	V <sub>CE</sub> = 5 V, I <sub>F</sub> = 20 mA		

#### Notes:

- (1) RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.
- (2) Derate linearly 1.67 mW/°C above 25 ° C.
- (3) Methanol or isopropanol are recommended as cleaning agents. Plastic housing is soluble in chlorinated hydrocarbons and ketones.
- (4) All parameters tested using pulse technique.

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## **OPB855 - Flag in Middle of Slot**

